

RD3CYDT08

IGBT Driver

REJ03D0905-0300
Rev.3.00
Apr 22, 2008

Description

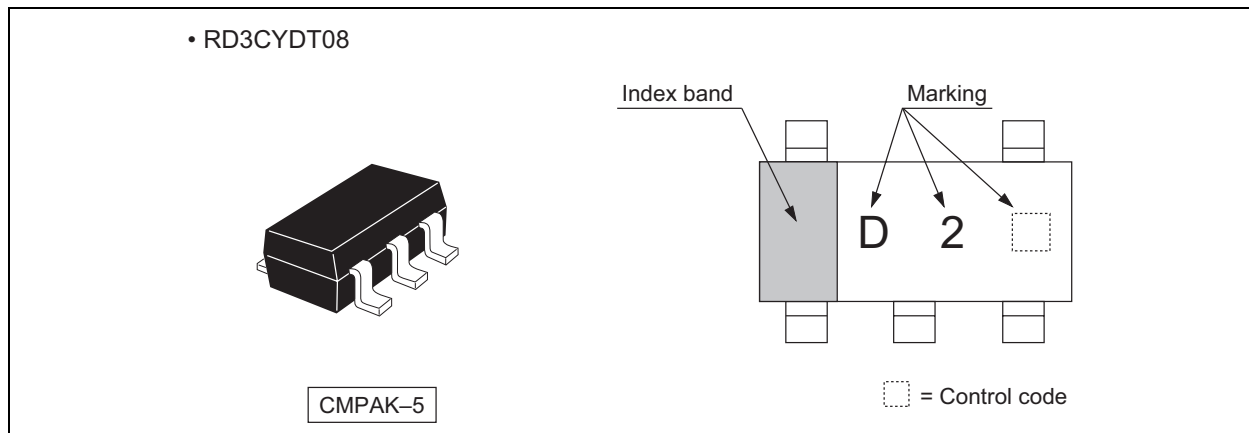
The RD3CYDT08 has two-input AND gate in a 5 pin package. This product is suited as IGBT Driver IC for the strobe.

Features

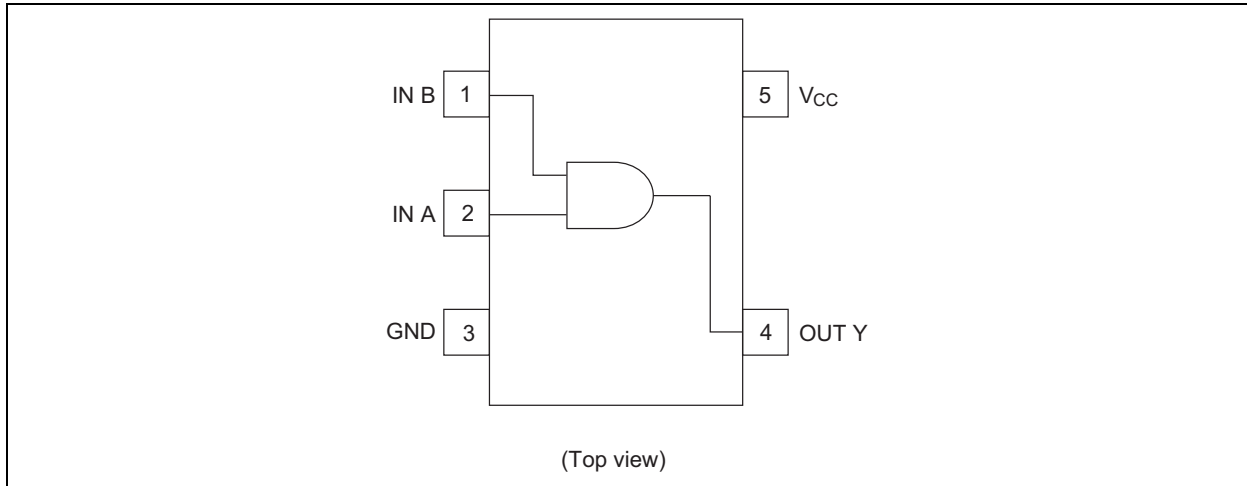
- Supplied on emboss taping for high-speed automatic mounting.
- Supply voltage range : 2.0 to 3.6 V
- Operating temperature range : -40 to +85°C
- High drive current
 $I_{OH \text{ short}} = -130 \text{ mA (typ) (@}V_{CC} = 3.3 \text{ V)}$
- Low sink current
 $I_{OL \text{ short}} = 45 \text{ mA (typ) (@}V_{CC} = 3.3 \text{ V)}$
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
RD3CYDT08CME	CMPAK-5 pin	PTSP0005ZC-A (CMPAK-5V)	CM	E (3,000 pcs/reel)

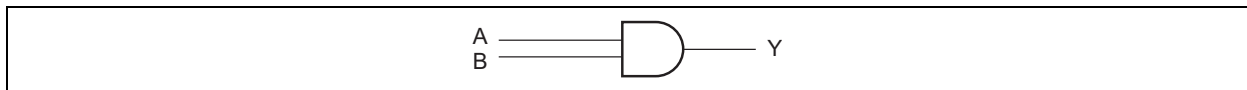
Outline and Article Indication



Pin Arrangement



Logic Diagram

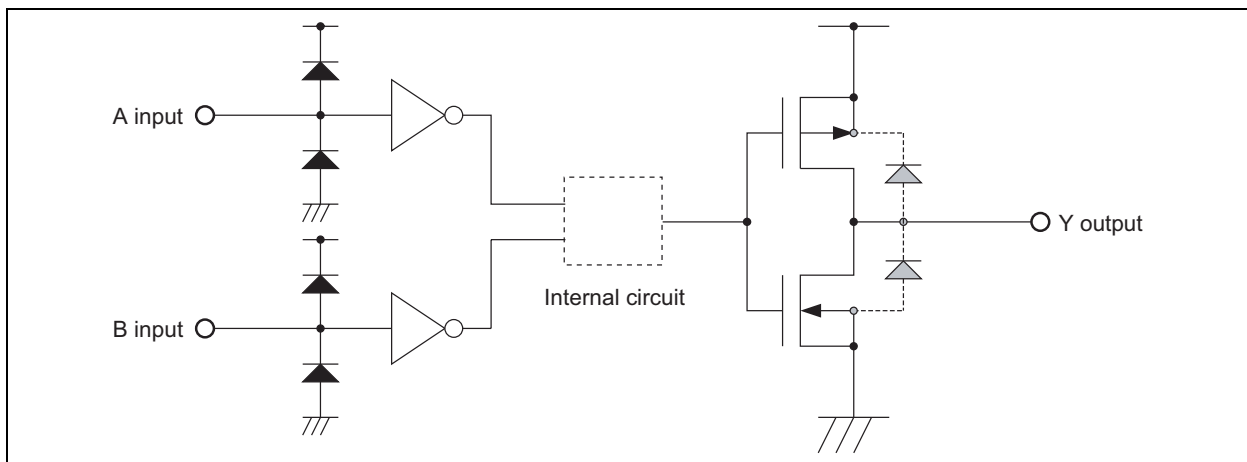


Function Table

Inputs		Output Y
A	B	
L	L	L
H	L	L
L	H	L
H	H	H

H : High level
L : Low level

Block Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V_{CC}	-0.5 to 4.6	V	
Input voltage range *1	V_I	-0.5 to $V_{CC} + 0.5$	V	
Output voltage range *1, 2	V_O	-0.5 to $V_{CC} + 0.5$	V	
Input clamp current	I_{IK}	± 50	mA	$V_I < 0$ or $V_I > V_{CC}$
Output clamp current	I_{OK}	± 50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I_O	-200	mA	$V_O = 0$
		100		$V_O = V_{CC}$
Continuous current through V_{CC} or GND	I_{CC} or I_{GND}	± 200	mA	
Maximum power dissipation at $T_a = 25^\circ\text{C}$ (in still air) *3	P_T	200	mW	
Storage temperature	T_{stg}	-65 to 150	$^\circ\text{C}$	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed. When Over shoot / Under shoot pulse width is under 10 ns, input and output voltage permit to -1.5 V or $V_{CC}+1.5\text{ V}$.
2. This value is limited to 4.6 V maximum.
3. The maximum package power dissipation was calculated using a junction temperature of 150°C .

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V_{CC}	2.0	3.6	V	
Input voltage range	V_I	0	V_{CC}	V	
Output voltage range	V_O	0	V_{CC}	V	
Input transition rise or fall rate	$\Delta t / \Delta V$	0	100	ns / V	
Operating free-air temperature	T_a	-40	85	$^\circ\text{C}$	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristic

$T_a = -40$ to 85°C

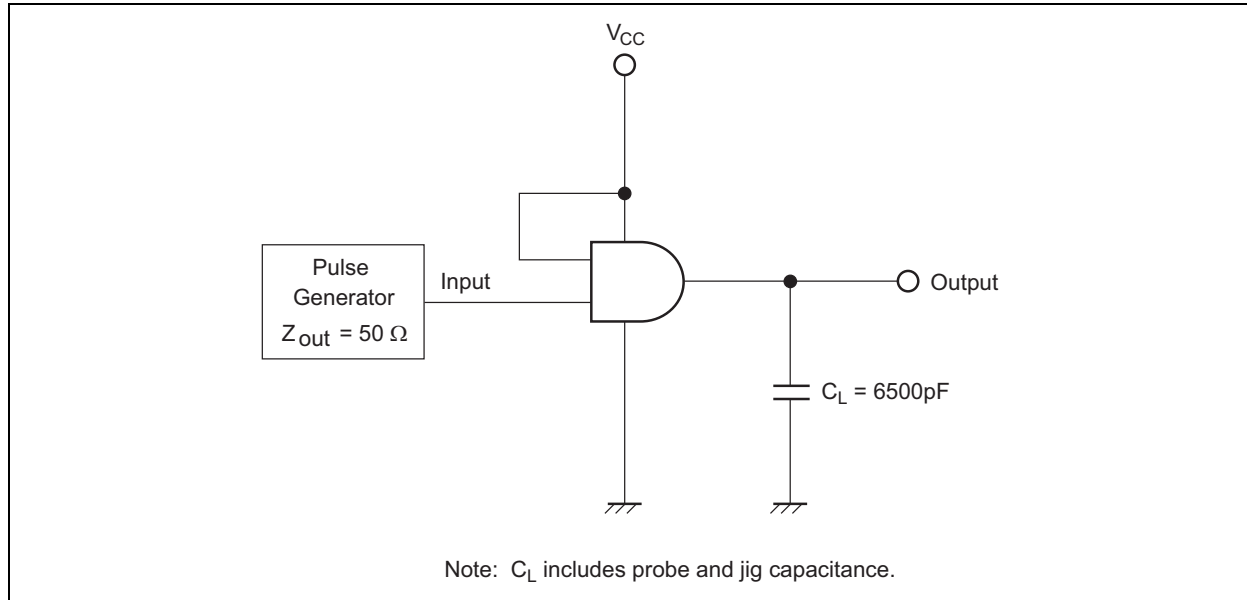
Item	Symbol	V_{CC} (V)	Min	Typ	Max	Unit	Test condition
Input voltage	V_{IH}	3.0 to 3.6	1.4	—	—	V	
	V_{IL}	3.0 to 3.6	—	—	0.5		
Output current	I_{OH} short	3.3	-100	-130	-160	mA	
	I_{OL} short	3.3	30	45	60		
Input current	I_{IN}	3.6	—	—	± 5	μA	$V_{IN} = 3.6\text{ V}$ or GND
Quiescent supply current	I_{CC}	3.6	—	—	10	μA	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Input capacitance	C_{IN}	3.3	—	2.5	—	pF	$V_{IN} = V_{CC}$ or GND

Switching Characteristics

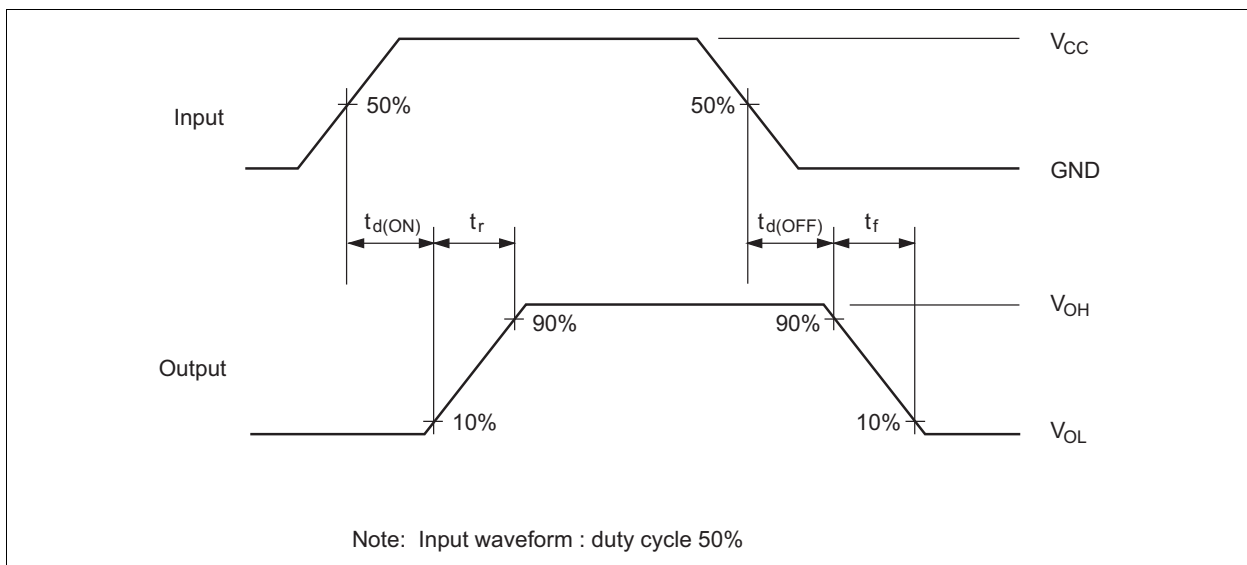
$V_{CC} = 3.3 \pm 0.3\text{ V}$

Item	Symbol	$T_a = -40$ to 85°C			Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max				
Propagation delay time	$t_{d(ON)}$	—	—	50	ns	$C_L = 6500\text{ pF}$	A or B	Y
	$t_{d(OFF)}$	—	—	160				
Output rise time	t_r	—	—	500				
Output fall time	t_f	—	—	1500				

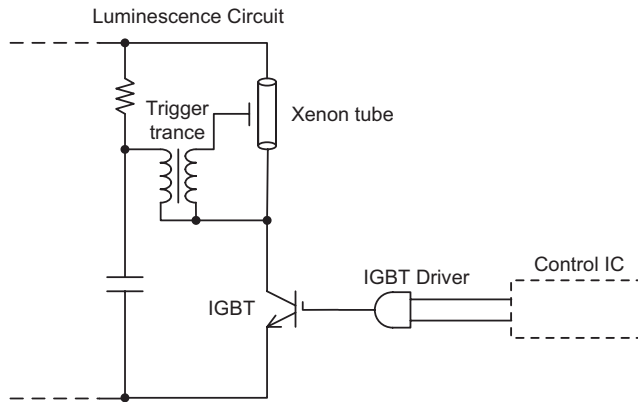
Test Circuit



Waveforms



Application Note (Strobe circuit)



Combination example

SYSTEM	IGBT	IGBT Driver	Control IC
3.3 V	RJP4002ANS RJP4002ASA	RD3CYD08 RD3CYDT08	3.3 V signal
5.0 V	RJP4003ANS RJP4003ASA	RD5CYD08 RD5CYDT08	5.0 V signal 3.3 V signal

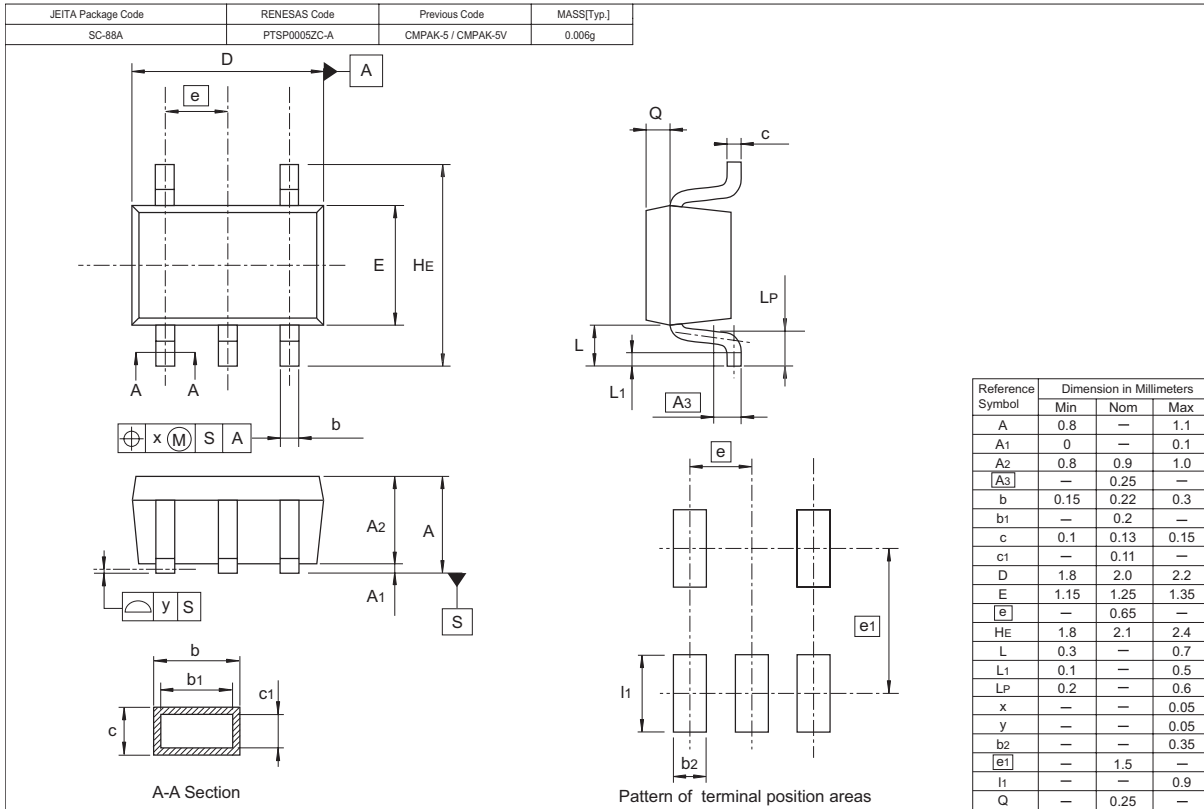
IGBT Driver Lineup

TYPE No.	Specification	Package
RD3CYD08	$V_{CC} = 2.0$ to $3.6V$ CMOS lever input $I_{OH}(short) = -130mA(typ)$ @ $V_{CC} = 3.3V$ $I_{OL}(short) = 45mA(typ)$ @ $V_{CC} = 3.3V$	CMPAK-5 VSON-5
RD3CYDT08	$V_{CC} = 2.0$ to $3.6V$ CMOS lever input $I_{OH}(short) = -130mA(typ)$ @ $V_{CC} = 3.3V$ $I_{OL}(short) = 45mA(typ)$ @ $V_{CC} = 3.3V$	CMPAK-5
RD5CYD08	$V_{CC} = 4.0$ to $6.0V$ CMOS lever input $I_{OH}(short) = -130mA(typ)$ @ $V_{CC} = 5.0V$ $I_{OL}(short) = 40mA(typ)$ @ $V_{CC} = 5.0V$	CMPAK-5
RD5CYDT08	$V_{CC} = 4.0$ to $6.0V$ TTL lever input $I_{OH}(short) = -130mA(typ)$ @ $V_{CC} = 5.0V$ $I_{OL}(short) = 40mA(typ)$ @ $V_{CC} = 5.0V$	

IGBT Lineup

TYPE No.	Specification	Package
RJP4002ANS	$V_{CES} = 400V(max)$, $I_{CP} = 150A(max)$, 2.5V drive	VSON-8
RJP4002ASA	$V_{CES} = 400V(max)$, $I_{CP} = 150A(max)$, 2.5V drive	TSSOP-8
RJP4003ANS	$V_{CES} = 400V(max)$, $I_{CP} = 150A(max)$, 4V drive	VSON-8
RJP4003ASA	$V_{CES} = 400V(max)$, $I_{CP} = 150A(max)$, 4V drive	TSSOP-8

Package Dimensions



Notes:

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